

**Tokyo Ohka Kogyo Co., Ltd. Announces
Establishment of Research and Development Building
for state-of-the-art Semiconductors Manufacturing Materials**

(For the purpose of promoting the research and development
for photolithography technology in future generations)

KAWASAKI, Kanagawa Prefecture, Japan, November 17, 2004 - Tokyo Ohka Kogyo Co., Ltd. (TOK) hereby announces establishment of research and development building within the premises of its Sagami Operation Center, for the purpose of further promotion of the research and development for semiconductors manufacturing materials in future generations.

Super clean room with ISO cleanliness class 3.5 (*note) or less will be established in the building, and the most-advanced facilities will be equipped in order to strongly advance the research and development related to photolithography technology to support microprocess with 45nm node process and beyond. For the first stage of such facilities installation, exposure tool related to support immersion exposure technology and others are considered to be equipped, which is necessary for 45nm node process.

In the process of semiconductors manufacturing, various photolithography technologies are examined along with the advance in its miniaturization, thus customer demands for semiconductors manufacturing materials are sophisticated and diversified in further. Therefore, the facilities with clean room meeting certain conditions such as cleanliness factor and the most-advanced equipments will be essential to research and develop extreme miniaturization in the semiconductor field in the near future.

TOK strongly advances “promoting diversified development of microprocess technology” and strives to extend its technology over numerous fields, especially in the semiconductor field, which is considered as driving force behind our technological progress. The research and development will be promoted and strengthened furthermore by this investment of the new facilities and equipments, and accordingly, we intend to ensure the further improvement of microprocess technology.

*Note: ISO cleanliness class 3.5 corresponds approximately to U.S. Federal Standard cleanliness class 10 (0.3 μ m). This means that there are 10 and below airborne particulate of 0.3 μ m and above per 1 cubic foot air.

Outline of the New Research and Development Building

- (1) Address: 1590, Tabata, Samukawa-machi, Koza-gun, Kanagawa Prefecture, Japan (within premises of TOK Sagami Operation Center)
- (2) Building Area: Approximately 1,600m²
- (3) Gloss Floor Area: Approximately 5,900m²
- (4) Structure: Steel-framed structure / 6 stories above the ground

(5) Investment: Approximately JP¥6.5 billion

(6) Scheduled times of completion: December 2005

Image of the New Research and Development Building



Forward-Looking Statement: This news release contains forward-looking statements based on management's current expectations, estimates and projections. All statements that address expectations or projections about the future, including statements about the company's strategy for growth, product development, market position, expected expenditures and financial results are forward-looking statements. Some of the forward-looking statements may be identified by words like "expects", "anticipates", "plans", "intends", "projects", "indicates", "believes", and similar expressions. These statements are not guarantees of future performance and involve a number of risks, uncertainties and assumptions. Many factors, including those discussed more fully elsewhere in this release and in TOK's filings with the Ministry of Finance of Japan and Tokyo Stock Exchange, Inc., particularly its latest annual report and semiannual report, as well as others, could cause results to differ materially from those stated. These factors include, but are not limited to changes in the laws, regulations, policies and economic conditions, including inflation, deflation, interest and foreign currency exchange rates, of countries in which the company does business; competitive pressures; successful integration of structural changes, including restructuring plans, acquisitions, divestitures and alliances; cost of raw materials, research and development of new products, including regulatory approval and market acceptance.

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